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January 2013



FJAFS1720 ESBC[™] Rated NPN Power Transistor

ESBC Features (FDS8817 MOSFET)

V _{CS(ON)}	Ι _C	Equiv. R _{CS(ON)}
0.304 V	10 A	0.0304 Ω ⁽¹⁾

- · Low Equivalent On Resistance
- Very Fast Switch: 150 kHz
- Squared RBSOA: Up to 1700 V
- Avalanche Rated
- Low Driving Capacitance, No Miller Capacitance
- Low Switching Losses
- Reliable HV Switch: No False Triggering due to High dv/dt Transients

Applications

- High-Voltage and High-Speed Power Switches
- Emitter-Switched Bipolar/MOSFET Cascode (ESBC[™])
- Smart Meters, Smart Breakers, SMPS, **HV Industrial Power Supplies**
- Motor Drivers and Ignition Drivers



Description

The FJAFS1720 is a low-cost, high-performance power switch designed to provide the best performance when used in an ESBC[™] configuration in applications such as: power supplies, motor drivers, smart grid, or ignition switches. The power switch is designed to operate up to 1700 volts and up to 12 amps, while providing exceptionally low on-resistance and very low switching losses.

The ESBC[™] switch is designed to be driven using off-theshelf power supply controllers or drivers. The ESBC" MOSFET is a low-voltage, low-cost, surface-mount device that combines low-input capacitance and fast switching, The ESBC[™] configuration further minimizes the required driving power because it does not have Miller capacitance.

The FJAFS1720 provides exceptional reliability and a large operating range due to its square reverse-bias-safeoperating-area (RBSOA) and rugged design. The device is avalanche rated and has no parasitic transistors, so is not prone to static dv/dt failures.

The power switch is manufactured using a dedicated high-voltage bipolar process and is packaged in a highvoltage TO-3PF package.

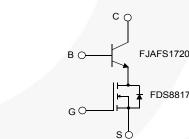


Figure 3. ESBC Configuration⁽²⁾

Ordering Information

Part Number	Marking	Package	Packing Method
FJAFS1720TU	J1720	TO-3PF	TUBE

R C

 $C \cap 2$

F ሪ 3

Figure 2. Internal Schematic Diagram

Notes:

- 1. Figure of Merit.
- 2. Other Fairchild MOSFETs can be used in this ESBC application.

Absolute Maximum Ratings⁽³⁾

Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Value	Units	
V _{CBO}	Collector-Base Voltage	1700	V	
V _{CEO}	Collector-Emitter Voltage	800	V	
V _{EBO}	Emitter-Base Voltage	6	V	
۱ _C	Collector Current (DC)	12	Α	
P _C	Collector Dissipation ($T_C = 25^{\circ}C$)	60	W	
TJ	Operating and Junction Temperature Range	-55 to +125	°C	
T _{STG}	Storage Temperature Range	-55 to +150	°C	

Note:

3. Pulse Test is Pulse Width \leq 5 ms, Duty Cycle \leq 10%.

Thermal Characteristics

Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Max.	Units
R _{θjC}	Thermal Resistance, Junction to Case	2.08	°C/W

Electrical Characteristics⁽⁴⁾

Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
I _{CES}	Collector Cut-off Current	V _{CB} = 1400 V, R _{BE} = 0			100	μA
I _{CBO}	Collector Cut-off Current	V _{CB} = 800 V, I _E = 0			10	μA
I _{EBO}	Emitter Cut-off Current	$V_{EB} = 4 V, I_{C} = 0$			100	μA
BV _{CBO}	Collector-Base Breakdown Voltage	$I_{\rm C} = 500 \ \mu \text{A}, \ I_{\rm E} = 0$	1700			V
BV _{CEO}	Collector-Emitter Breakdown Voltage	I _C = 5 mA, I _B = 0	800			V
BV _{EBO}	Base-Emitter Breakdown Voltage	I _E = 500 μA, I _C = 0	6			V
h _{FE1}	DC Current Gain	V _{CE} = 5 V, I _C = 1 A	8.0			
h _{FE2}		V _{CE} = 5 V, I _C = 11 A	5.5		8.5	
		I _C = 10 A, I _B = 3.33 A, h _{FE} = 3		0.25		V
V _{CE} (sat) Col	Collector-Emitter Saturation Voltage	I _C = 5 A, I _B = 1.0 A, h _{FE} = 5		0.20		V
		I _C = 1 A, I _B = 0.1 A, h _{FE} = 10		0.20		V
V _{BE} (sat)	Base-Emitter Saturation Voltage	I _C = 10 A, I _B = 3.33 A, h _{FE} = 3		0.86		V

Note:

4. Pulse Test: Pulse Width 5 ms, Duty Cycle 10%.

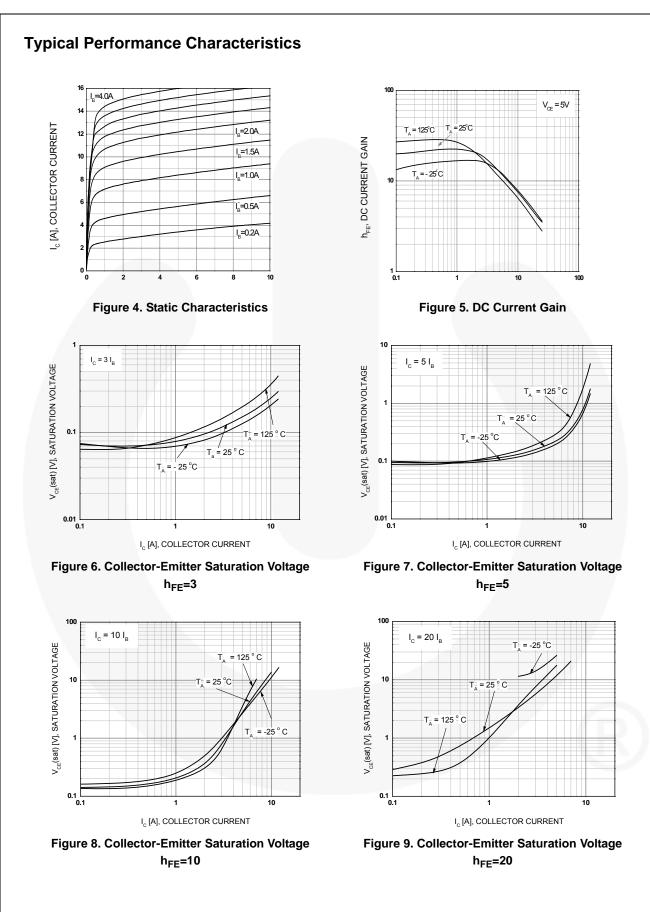
ESBC Configured Electrical Characteristics⁽⁵⁾

Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

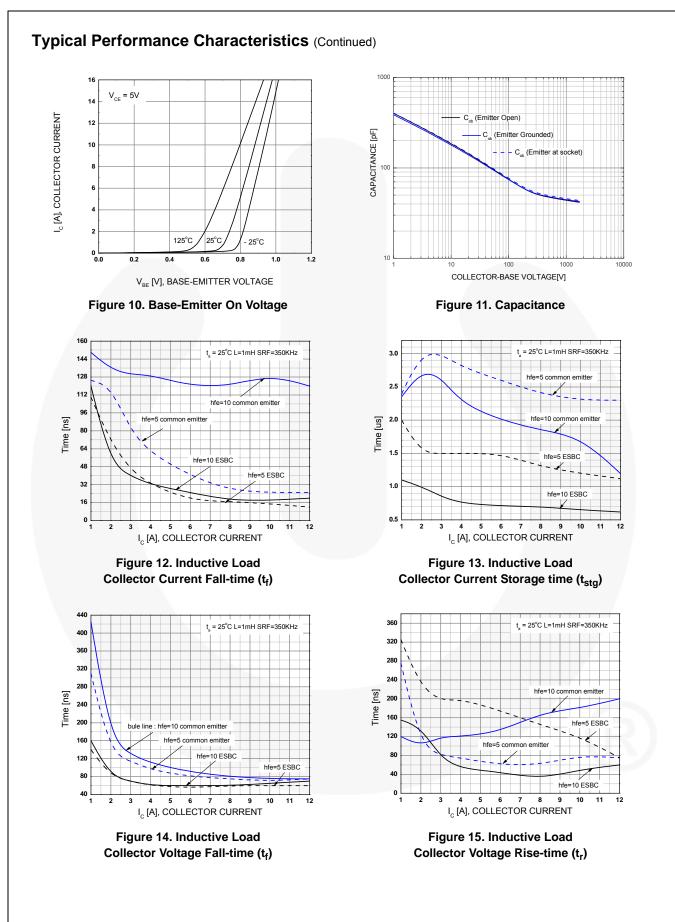
Symbol	Parameter Test Conditions		Min.	Min. Typ.		Units
f _T	Current Gain Bandwidth Product	I _C = 0.1 A,V _{CE} = 10 V		15		MHz
lt _f	Inductive Current Fall Time	V _{GS} = 10 V, R _G = 47 Ω,		60		ns
t _s	Inductive Storage Time	$V_{Clamp} = 500 V,$		1000		ns
Vt _f	Inductive Voltage Fall Time	I _C = 2 A, I _B = 0.2 A, h _{FE} = 10		85		ns
Vt _r	Inductive Voltage Rise Time	$L_{\rm C} = 1 \rm mH$,		125		ns
t _c	Inductive Crossover Time	SRF = 350 kHz		165		ns
lt _f	Inductive Current Fall Time	V _{GS} = 10 V, R _G = 47 Ω,		24		ns
t _s	Inductive Storage Time	$V_{Clamp} = 500 V,$		1500		ns
Vt _f	Inductive Voltage Fall Time	$I_{C} = 5 \text{ A}, I_{B} = 1 \text{ A}, h_{FE} = 5$		85		ns
Vt _r	Inductive Voltage Rise Time	L _C = 1 mH,		65		ns
t _c	Inductive Crossover Time	SRF = 350 kHz		110		ns
V _{CSW}	Maximum Collector Source Voltage at Turn-off without Snubber	h _{FE} = 5, I _C = 6 A	1700			V
I _{GS(OS)}	Gate-Source Leakage Cur- rent	V _{GS} = ±20 V		1.0		nA
		V_{GS} = 10 V, I _C = 10 A, I _B = 3.3 A, h _{FE} = 3		0.3040		V
.,	Collector-Source On Voltage	V _{GS} = 10 V, I _C = 6 A, I _B = 2 A, h _{FE} = 3		0.2124		V
V _{CS(ON)}		V _{GS} = 10 V, I _C = 3 A, I _B = 1 A, h _{FE} = 3		0.1362		V
		V _{GS} = 10 V, I _C = 3 A, I _B = 0.6 A, h _{FE} = 5		0.1662		V
V _{GS(th)}	Gate Threshold Voltage	V _{BS} = V _{GS} , I _B = 250 μA		1.9		V
C _{iss}	Input Capacitance $(V_{GS} = V_{CB} = 0)$	V _{CS} = 25 V, f = 1 MHz		1805		pF
Q _{GS(tot)}	Gate-Source Charge V _{CB} =0	V_{GS} = 10 V, I _C = 6 A, V _{CS} = 25 V		6		nC
. /	Static Drain-Source On Resistance	V _{GS} = 10 V, I _D = 15 A		5.4		mΩ
r _{DS(ON)}		V _{GS} = 10 V, I _D = 15 A, T _A = 125 °C		7.5		mΩ
()		V _{GS} = 4.5 V, I _D = 12.6 A		7.0		mΩ

Note:

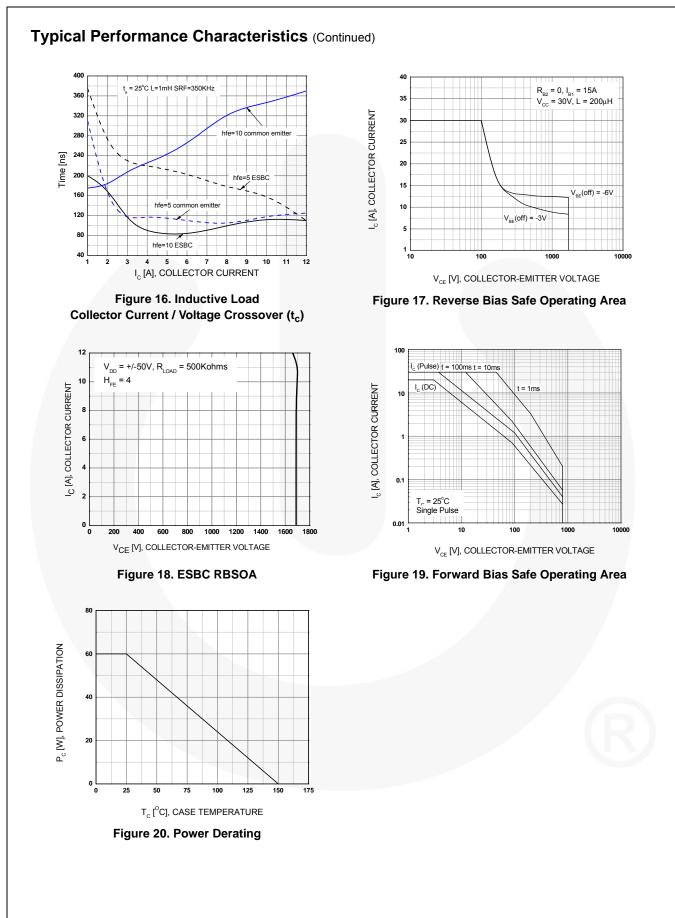
5. Used typical FDS8817 MOSFET specifications in table. Table could vary if other Fairchild MOSFETs are used.

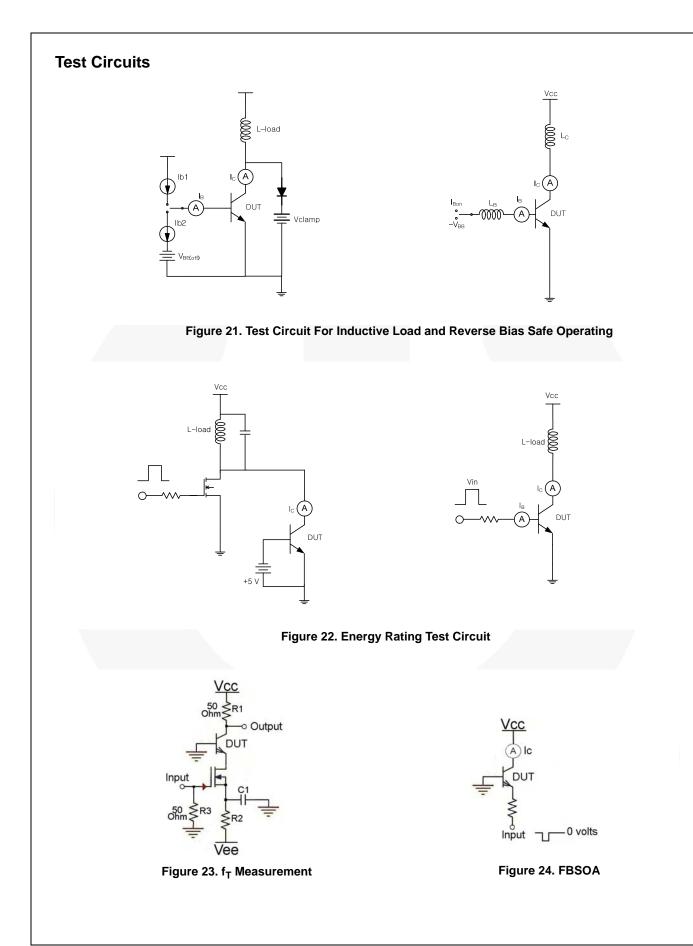






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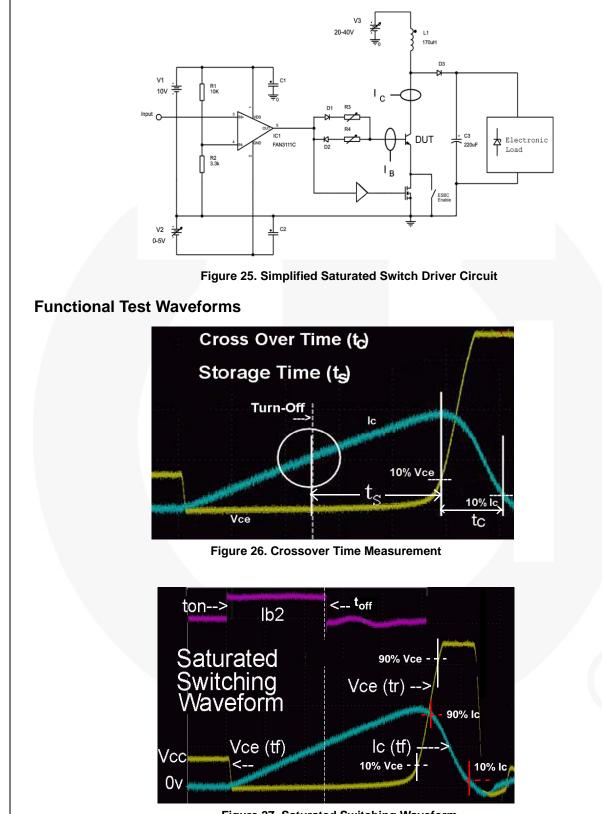
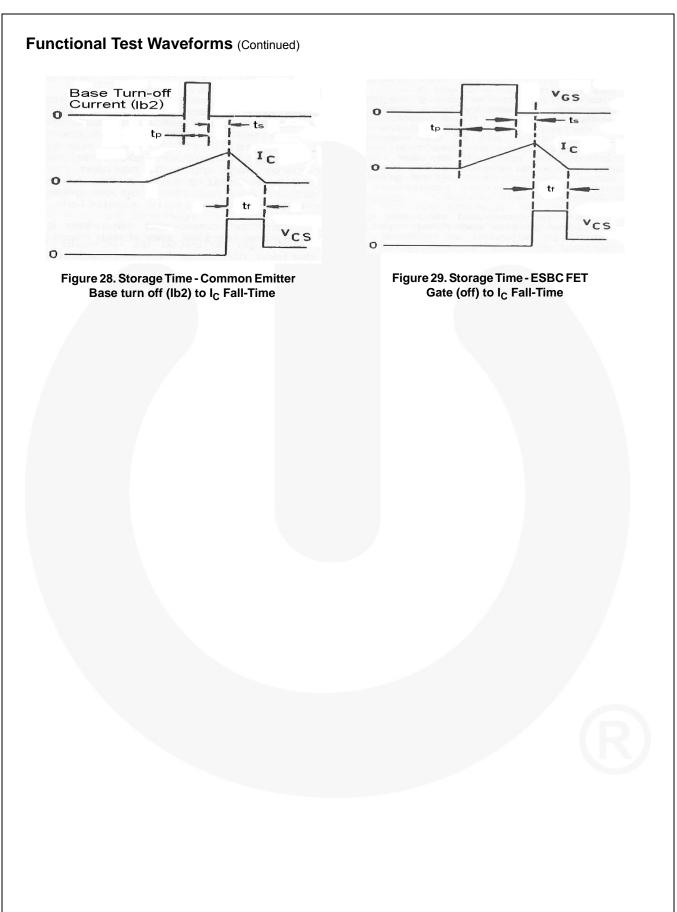


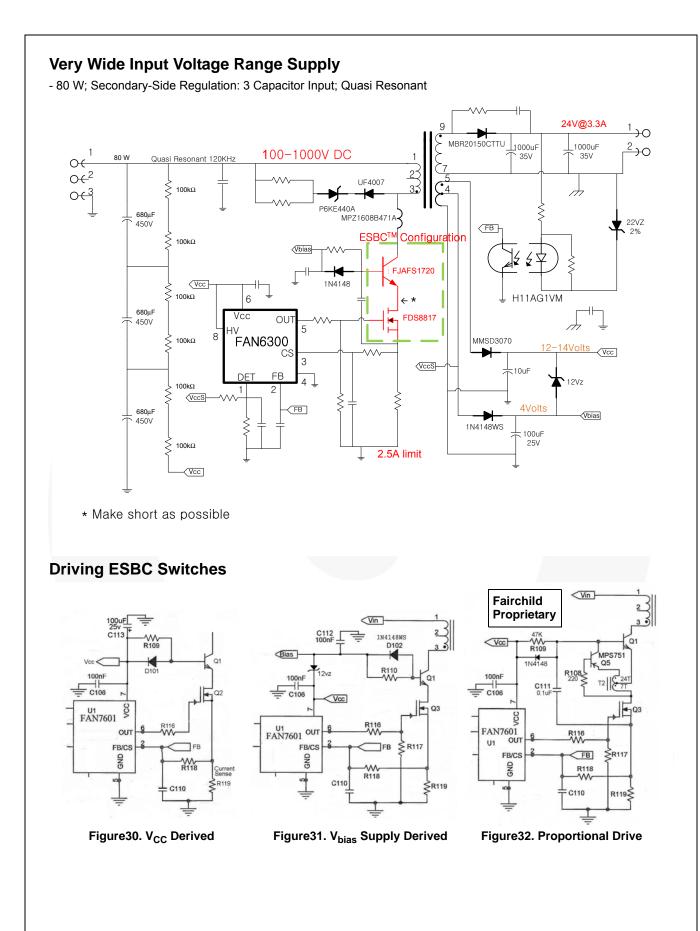
Figure 27. Saturated Switching Waveform

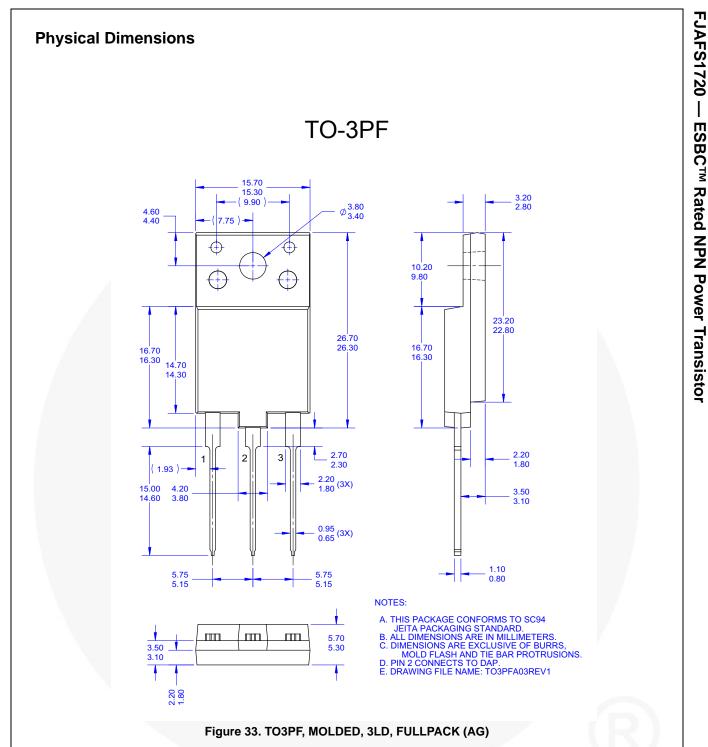
Test Circuits (Continued)











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